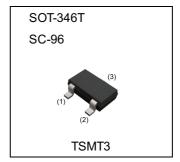


## PNP -2.0A -30V Middle Power Transistor

Parameter	Value		
V <sub>CEO</sub>	-30V		
IC	-2A		

## Outline

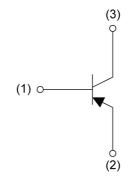


### Features

- 1)Suitable for Middle Power Driver
- 2)Complementary NPN Types:2SCR512R
- 3)Low  $V_{CE(sat)}$

 $V_{CE(sat)}$ =-400mV(Max.) ( $I_{C}/I_{B}$ =-700mA/-35mA)

## •Inner circuit



- (1) Base
- (2) Emitter
- (3) Collector

# Application

LOW FREQUENCY AMPLIFIER, HIGH SPEED SWITCHING

# Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SAR512R	SOT-346T (TSMT3)	2928	TL	180	8	3000	MB

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	$V_{CBO}$	-30	V
Collector-emitter voltage	V <sub>CEO</sub>	-30	V
Emitter-base voltage	$V_{EBO}$	-6	V
Callegtor augrent	I <sub>C</sub>	-2	Α
Collector current	I <sub>CP</sub> *1	-4	Α
Dower discination	$P_{D}^{*2}$	0.5	W
Power dissipation	P <sub>D</sub> *3	1.0	W
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

# • Electrical characteristics $(T_a = 25^{\circ}C)$

Dovometer	Cumbal	Conditions	Values			Lloit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = -100μA	-30	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = -1mA	-30	-	-	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = -100μA	-6	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -30V	ı	-	-1.0	μA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -4V	ı	-	-1.0	μA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub> *4	$I_C = -700 \text{mA}, I_B = -35 \text{mA}$	-	-200	-400	mV
DC current gain	h <sub>FE</sub>	$V_{CE} = -2V, I_{C} = -100 \text{mA}$	200	-	500	-
Transition frequency	f <sub>T</sub> *4	$V_{CE} = -10V, I_{E} = 100mA,$ f = 100MHz	-	430	-	MHz
Output capacitance	C <sub>ob</sub>	$V_{CB} = -10V, I_E = 0A,$ f = 1MHz	-	15	-	pF
Turn-On time	t <sub>on</sub>	I <sub>C</sub> = -1A, I <sub>B1</sub> = -100mA,	1	30	-	ns
Storage time	$t_{stg}$	$I_{B2} = 100 \text{mA},$ $V_{CC} \simeq -10 \text{V},$	-	170	-	ns
Fall time	t <sub>f</sub>	$R_L = 10\Omega$ See test circuit	1	15	-	ns

<sup>\*1</sup> PW=10ms ,Single pulse

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3</sup> Mounted on a ceramic board(40×40×0.7mm).

<sup>\*4</sup> Pulsed

# ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.1 Ground Emitter Propagation Characteristics

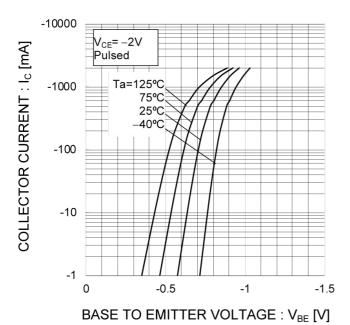
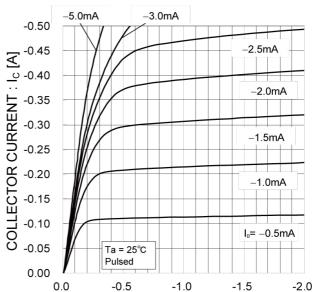


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current Gain vs. Collector Current (I)

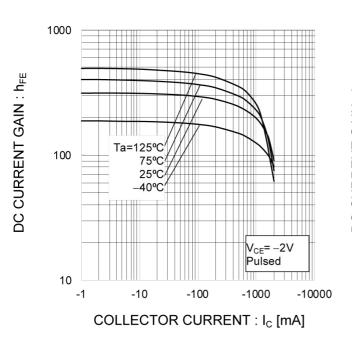
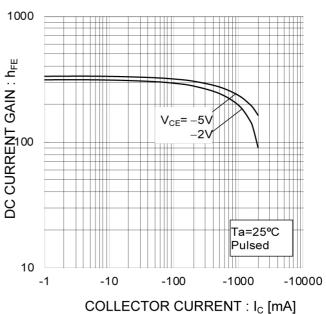


Fig.4 DC Current Gain vs. Collector Current (II)



# ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

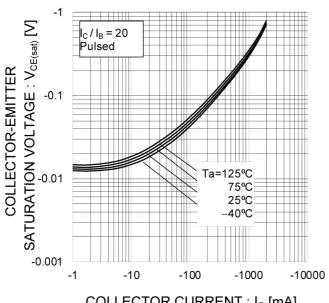
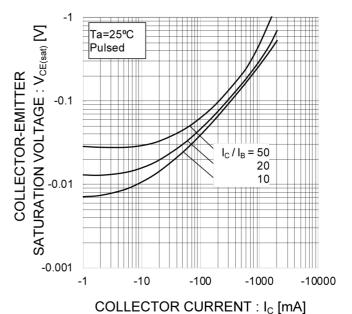


Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current (II)



COLLECTOR CURRENT: Ic [mA]

Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

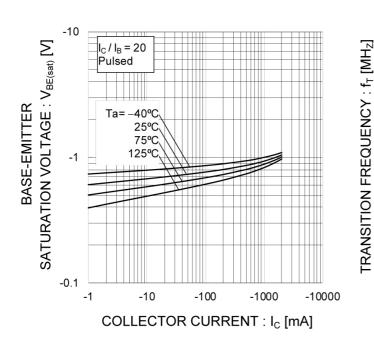
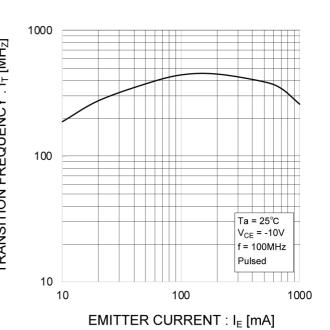


Fig.8 Gain Bandwidth Product vs. **Emitter Current** 



# ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.9 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

-10

Ta=25°C

Mounted on a reference land.
Single non repetitive pulse.

COLLECTOR TO EMITTER VOLTAGE: VCE [V]

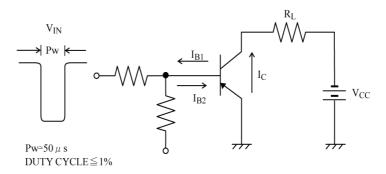
-10

Fig.10 Safe Operating Area

COLLECTOR-BASE VOLTAGE: V<sub>CB</sub> [V]

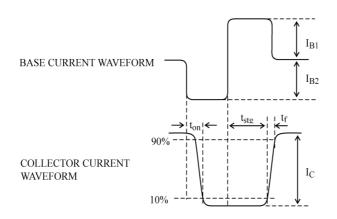
EMITTER-BASE VOLTAGE: V<sub>CB</sub> [V]

## SWITCHING TIME TEST CIRCUIT



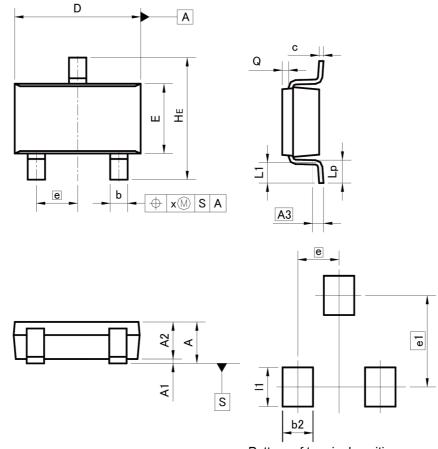
-0.001

-0.1



# Dimensions

TSMT3



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	I	1.00	-	0.039
A1	0.00	0.10	0.000	0.004
A2	0.75	0.95	0.030	0.037
A3	0.5	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.10	0.26	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.9	95	0.0	37
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.05	0.25	0.002	0.010
Х	_	0.20	_	0.008

DIM MILIMETERS		MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b2		0.70	-	0.028
e1	2.10		0.0	83
l1	_	0.90	ı	0.035

Dimension in mm/inches



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JÁPAN	USA	EU	CHINA
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CLASSIV	CLASSⅢ	CLASSⅢ	CLASSII

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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